

SYNTON-TECH CORPORATION LOW VALUE WIRE RESISTORS

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 RW-02

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 2021.01.01

1. SUBJECT

This specification applies on the low value wire resistors was made by **SYNTON-TECH** Corporation.

2. QUALITY

The resistor is manufactured by highly quality-controlled process and guaranteed high reliability.

3. STANDARD MEASURING CONDITIONS

Temperature $20\pm2^{\circ}$ C, Humidity $65\pm5\%$. Being no doubt About the judgment, measurements can be made within the following Temperature $5\sim35^{\circ}$ C, Humidity $45\sim85\%$.

APPROVED	CHECKED	DESIGNED	REMARK	DOCUMENT NO.
Carol	May	Chen		0201010185
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5. MATERIAL

Symbol	Material	Components
CMW	Copper-Manganese wire	Cu, Mn, Ni, Fe

6. FEATURES

d (mm)	Max. rating current (A)	Resistance range (m Ω)	Operating Temp.
0.6	3.0	$50 \sim 100$	
0.7	4.0	$20 \sim 70$	
0.8	4.5	$10 \sim 50$	
0.9	5.0	$10 \sim 40$	
1.0	5.5	$10 \sim 30$	
1.1	6.0	$6 \sim 20$	
1.2	7.0	$2.5 \sim 20$	-40°C
1.3	7.5	$5 \sim 20$	
1.4	8.0	$5 \sim 20$	
1.5	9.0	$3 \sim 20$	+200°C
1.6	9.5	$3 \sim 20$	
1.8	11	$3 \sim 10$	
2.0	12	$3 \sim 10$	
2.3	14	$3 \sim 5$	
2.5	15	$3 \sim 5$	

**Customized resistance values are available upon request

Figure1







SYNTON-TECH CORPORATION

LOW VALUE WIRE RESISTORS

8. PERFORMANCE SPECIFICTIONS

Item	Performance		Test methods (Conform to JIS C 5201)	
Resistance and Tolerance	Over 2.5m ohm ±5% (J) Below 2.5m ohm ±10% (K)		Comply with 4.5	
Temperature coefficient	Copper-Man ganese Wire ±10	00PPM/°C	Comply with 4.8 R_0 : Resistance value at room temp. (T ₀). R_1 : Resistance value at room temp. plus 100°C (T ₁).	
Short time overload	within ±2% No evidence of mechanical damage.		Comply with 4.13 Rated voltage X 2.5 times, 5s	
Terminal strength	No evidence of mechanical damage.		Wire dimension over 1.0mm 5kg/10sec. Wire dimension below 0.8mm 2kg/10sec.	
Resistance to soldering heat	within ±1% No evidence of mechanical damage.		$260\pm5^{\circ}$ C, 3.5 ± 0.5 s After test leave for 3hours.	
Solderability	Covered with new solder by 95% at least.		Test temperature of solder: 235±5°C Dipping time in solder: 3±0.5s	
Temperature cycle	within ±1% No evidence of mechanical damage.		Low side : -40±3°C/30min, Room temp. : 10 to 15min High side : 200±2°C/30min, Room temp. : 10 to 15min 5 cycles	
Load life in humidity	within ±5%		40±2°C, 90 to 95%RH, 1000hours Rated voltage (90 min ON, 30 min OFF)	
Load life	within ±5%		70±2°C, 1000hours Rated voltage (90 min ON, 30 min OFF)	
	L	Figure5		